

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



November 2014

FCPF400N80ZL1 N-Channel SuperFET[®] II MOSFET 800 V, 11 A, 400 mΩ

Features

- Typ. R_{DS(on)} = 340 mΩ
- Ultra Low Gate Charge (Typ. Q_q = 43 nC)
- Low E_{oss} (Typ. 4.1 uJ @ 400 V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 138 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

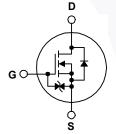
Applications

- AC-DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter Drain to Source Voltage			FCPF400N80ZL1	Unit V	
V _{DSS}				800		
V _{GSS}	Gate to Source Voltage	- DC		±20	V	
		- AC	(f >1 Hz)	±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		11*	Α	
		- Continuous (T _C = 100 ^o C)		6.9*		
I _{DM}	Drain Current	- Pulsed	(Note 1)	33*	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2			339	mJ	
I _{AR}	Avalanche Current	(Note 1)	2.2	Α		
E _{AR}	Repetitive Avalanche Energy		(Note 1)	0.36	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt			20		
P _D	Dower Discinction	(T _C = 25 ^o C)		35.7	W	
	Power Dissipation	- Derate Above 25°C		0.29	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FCPF400N80ZL1	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	3.5	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	0/11	

Part Nu	mber	Top Mark	Package	Packing Method	Reel Siz	e	Tape Width	ı Qu	antity	
FCPF400			TO-220F	Tube	N/A		N/A	50 units		
Electrica	al Char	acteristics T _C = 25°	C unless oth	nerwise noted.						
Symbol		Parameter		Test Conditions	s	Min.	Тур.	Max.	Unit	
Off Chara	cteristic	S								
BV _{DSS}	Drain to	Drain to Source Breakdown Voltage		V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C			-	-	V	
ΔBV_{DSS}		Breakdown Voltage Temperature				800	0.0			
$/\Delta T_{J}$	Coefficient		ID	$I_D = 1 \text{ mA}$, Referenced to 25° C			0.8	-	V/º(
I _{DSS}	Zero Ga	Zero Gate Voltage Drain Current		_S = 800 V, V _{GS} = 0 V				25	μA	
'DSS	2010 00			$V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	250	μΛ	
I _{GSS}	Gate to Body Leakage Current		VG	V _{GS} = ±20 V, V _{DS} = 0 V		-	-	±10	μA	
On Chara	cteristic	s								
	/			$_{SS} = V_{DS}, I_{D} = 1.1 \text{ mA}$		2.5	-	4.5	V	
V _{GS(th)}	Gate Threshold Voltage			$_{SS} = V_{DS}, I_{D} = 0.68 \text{ mA}$		2.5	-	4.5		
				$_{SS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$			0.34	0.4	+	
R _{DS(on)}	Static Drain to Source On Resistance			$_{SS} = 10 \text{ V}, \text{ I}_{D} = 7.1 \text{ A}$		-	0.35	0.4	Ω	
D0(011)				_{SS} = 10 V, I _D = 7.1 A, T	_C = 150 ^o C	-	0.89	-	1	
9 _{FS}	Forward	d Transconductance		_{DS} = 20 V, I _D = 5.5 A	0	-	12	-	S	
Dynamic (Charact	aristics			¥					
C _{iss}	1	apacitance					1770	2350	pF	
C _{oss}		Capacitance	V	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		_	51	70	pF	
C _{rss}		e Transfer Capacitance	f =			-	0.5	-	pF	
C _{oss}		Capacitance	Ve	V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz		-	28	-	pF	
	-	e Output Capacitance		$V_{\rm DS} = 400$ V, $V_{\rm GS} = 0$ V, $1 = 100$ M/2		-	138	-	pF	
C _{oss(eff.)} Q _{g(tot)}		ate Charge at 10V				-	43	56	nC	
Q_{gs}		Source Gate Charge		$V_{DS} = 640 \text{ V}, \text{ I}_{D} = 11 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	8.6	-	nC	
Q _{gd}		Drain "Miller" Charge	• (-	17	-	nC	
ESR		ent Series Resistance	f =	1 MHz	, ,	-	2.3	-	Ω	
						-				
Switching	Charac	teristics								
t _{d(on)}	Turn-On	Delay Time		V_{DD} = 400 V, I _D = 11 A, V _{GS} = 10 V, R _g = 4.7 Ω		-	20	50	ns	
t _r	Turn-On	Rise Time	VD				12	34	ns	
t _{d(off)}	Turn-Off	Delay Time	VG			-	51	112	ns	
t _f	Turn-Off Fall Time			(Note 4)		-	2.6	15	ns	
Drain-Sou	rce Dio	de Characteristics								
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	-	11	А			
I _{SM}	Maximum Pulsed Drain to Source Diode F					-	-	33	A	
V _{SD}		Source Diode Forward Vol			-	-	1.2	V		
t _{rr}		Recovery Time	-	$V_{GS} = 0 V, I_{SD} = 11 A,$		-	395	-	ns	
Q _{rr}		Recovery Charge		$dl_F/dt = 100 A/\mu s$			7.4	-	μC	

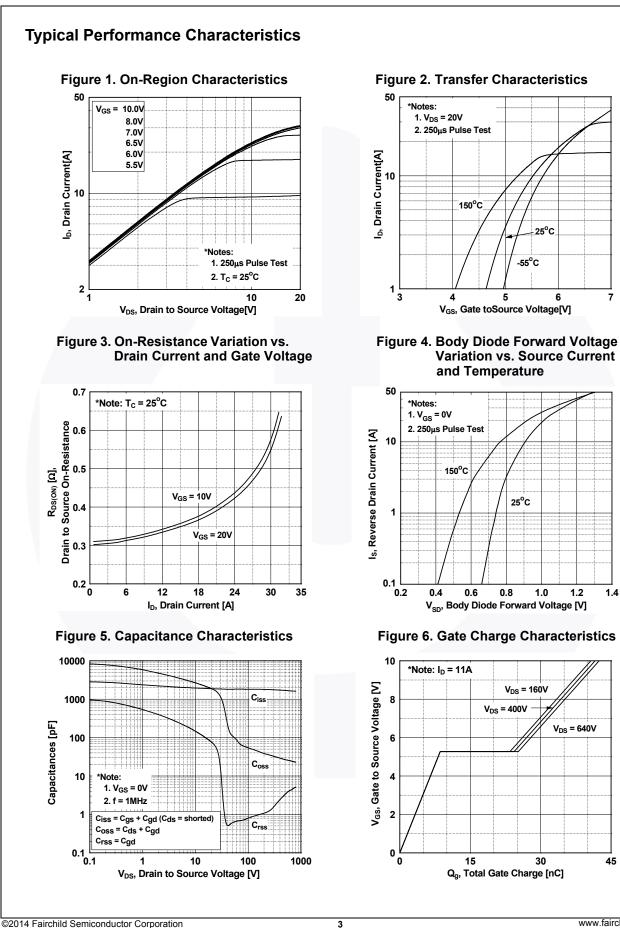
1. Repetitive rating: pulse-width limited by maximum junction temperature.

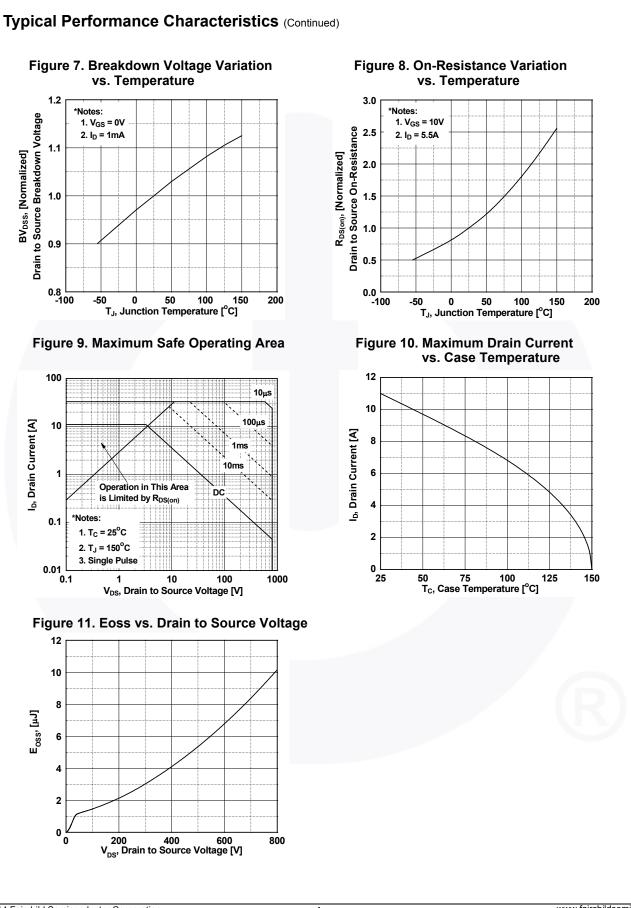
2. I_{AS} = 2.2 A, V_{DD} = 50 V, R_G = 25 $\Omega,$ starting T_J = 25°C.

3. I_{SD} \leq 11 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

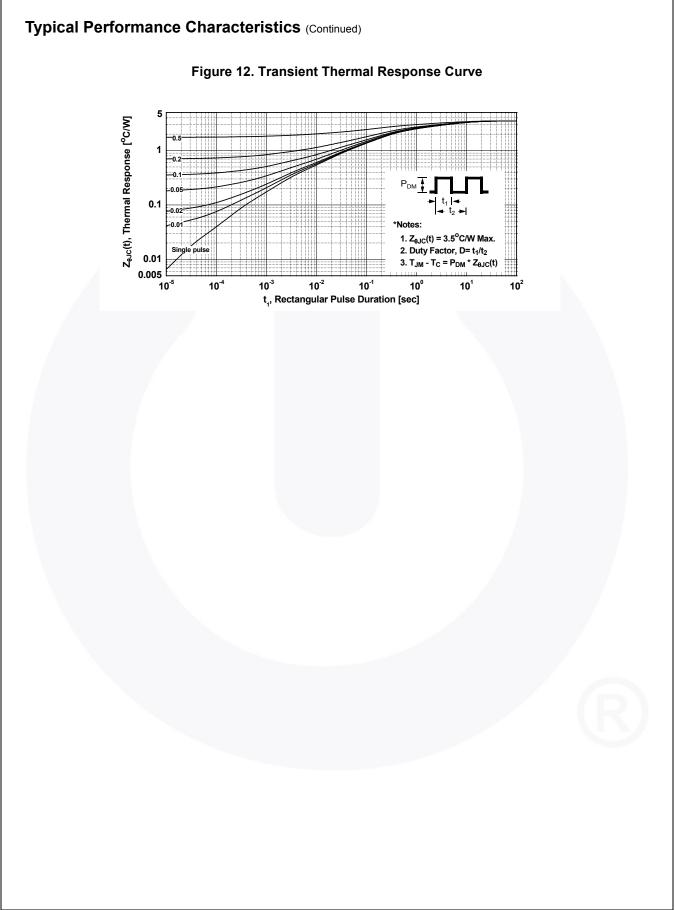
4. Essentially independent of operating temperature typical characteristics.

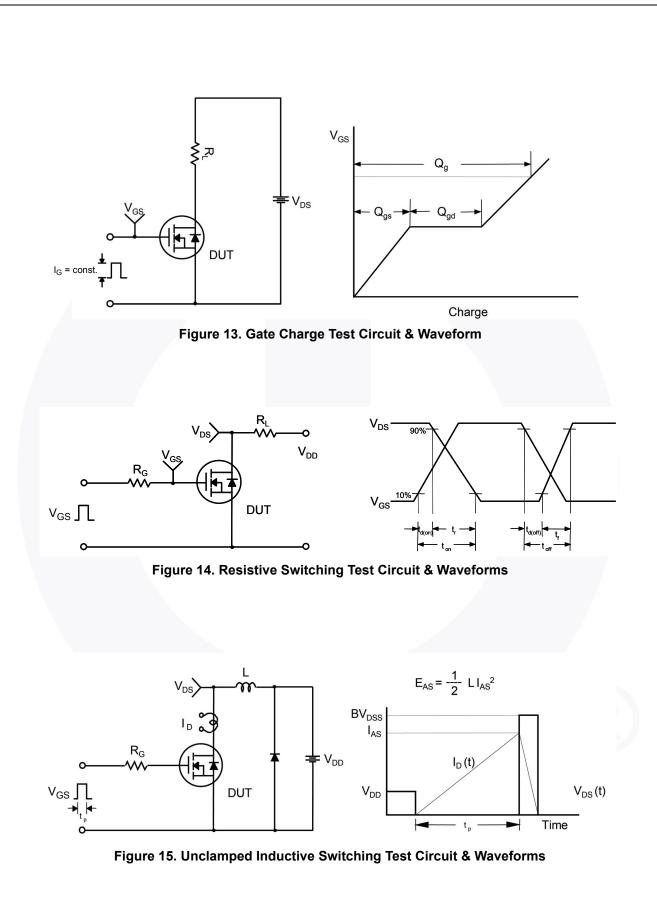
FCPF400N80ZL1 — N-Channel SuperFET[®] II MOSFET





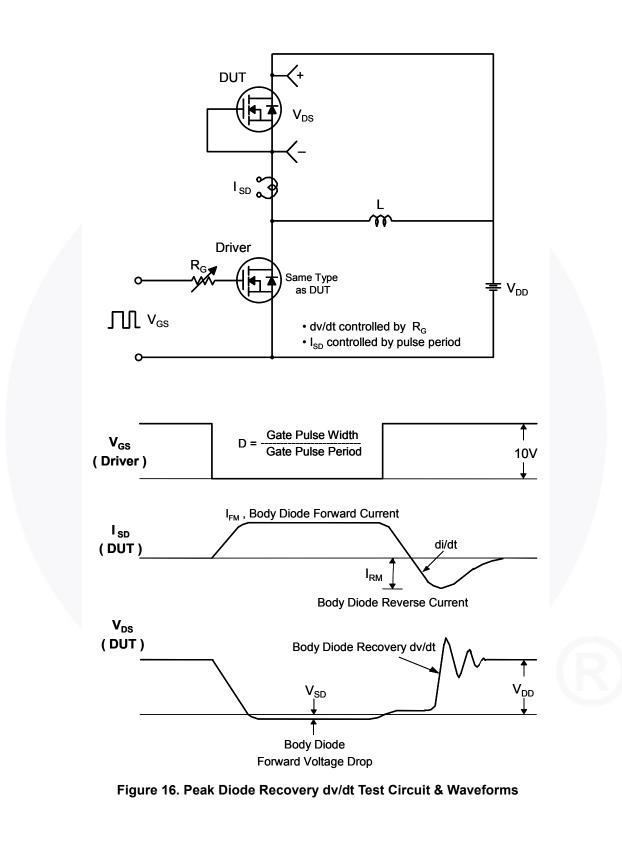
4

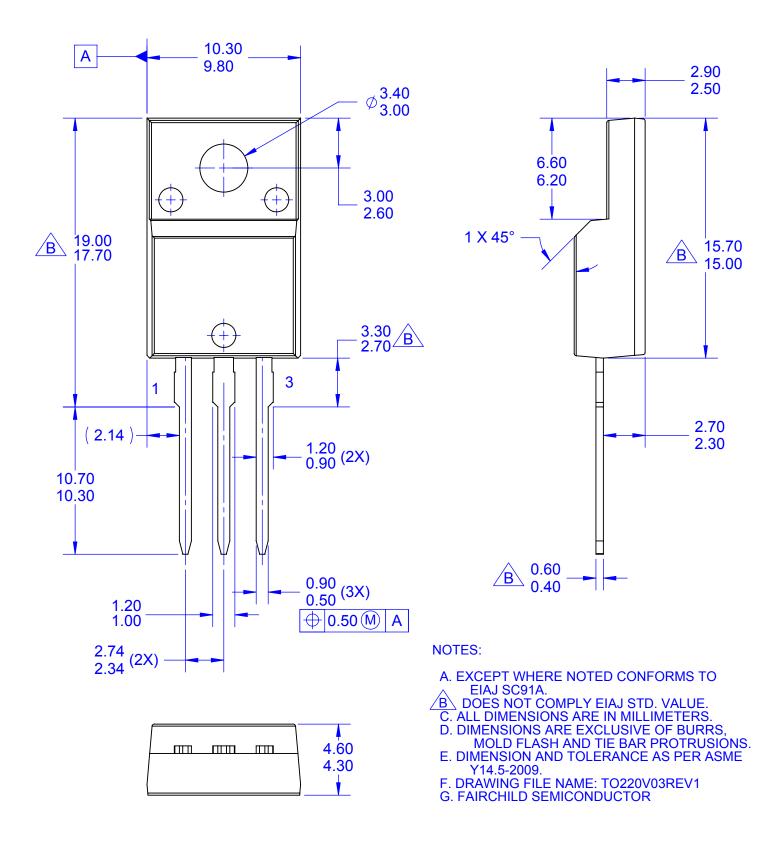




FCPF400N80ZL1 — N-Channel SuperFET[®] II MOSFET

FCPF400N80ZL1 — N-Channel SuperFET[®] II MOSFET





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC